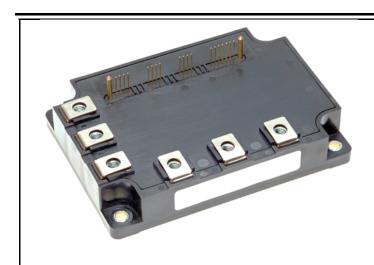


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PM100RG1C120

FLAT-BASE TYPE INSULATED PACKAGE

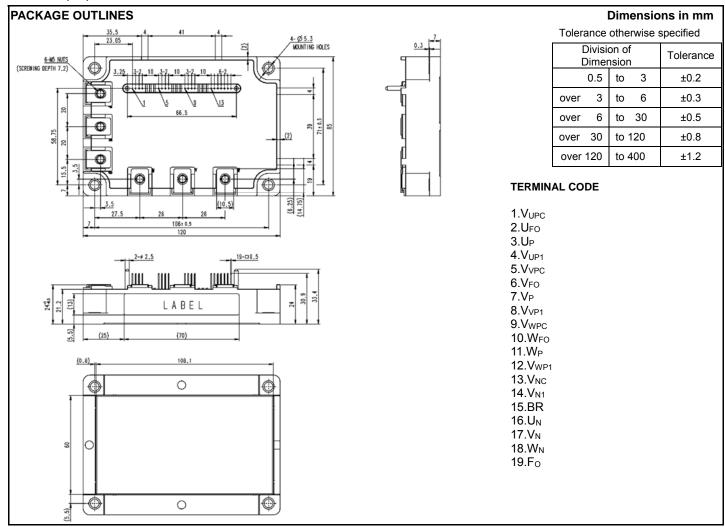


FEATURE

- a) Adopting Full-Gate CSTBT™ chip.
- b) The over-temperature protection which detects the chip surface temperature of CSTBT™ is adopted.
- c) Error output signal is available from each protection upper and lower arm of IPM.
- d) Outputting an error signal corresponding to the abnormal state (error mode identification)
- UL Recognized under UL1557, File No. E323585
 This product is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU.

APPLICATION

General purpose inverter, servo drives and other motor controls



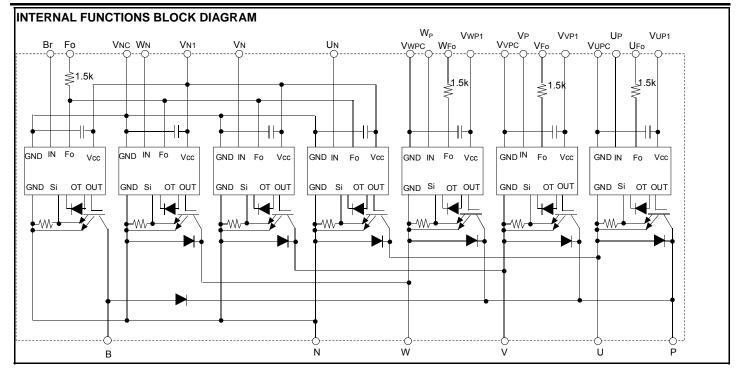
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Publication date: Nov, 2017

PM100RG1C120

HIGH POWER SWITCHING USE

INSULATED TYPE



MAXIMUM RATINGS (Tvj = 25°C, unless otherwise noted)

INVERTER PART

Symbol	Parameter	Conditions	Ratings	Unit
V_{CES}	Collector-Emitter Voltage	V _D =15 V, V _{CIN} =15 V	1200	V
Ic	-Collector Current	T _C =25 °C	100	^
I _{CRM}	-Collector Current	Pulse	200	Α
P_{tot}	Total Power Dissipation	T _C =25 °C	735	W
l _E	Emitter Current	T _C =25 °C	100	_
I _{ERM}	(Free-wheeling Diode Forward current)	Pulse	200	Α
Tvj	Junction Temperature		-20 ~ +150	°C

^{*:} Tc measurement point is just under the chip.

BRAKE PART

Symbol	Parameter	Conditions	Ratings	Unit
V_{CES}	Collector-Emitter Voltage	V _D =15 V, V _{CIN} =15 V	1200	V
Ic	Collector Current	T _C =25 °C	50	^
I _{CRM}	Collector Current	Pulse	100	A
P _{tot}	Total Power Dissipation	T _C =25 °C	480	W
V _{R(DC)}	Diode Rated Reverse DC Voltage	T _C =25 °C	1200	V
I _F	Diode Forward Current	T _C =25 °C	50	Α
Tj	Junction Temperature		-20 ~ +150	°C

^{*:} Tc measurement point is just under the chip.

CONTROL PART

Symbol	Parameter	Conditions	Ratings	Unit
V_D	Supply Voltage	Applied between: V _{UP1} -V _{UPC} , V _{VP1} -V _{VPC} , V _{WP1} -V _{WPC} , V _{N1} -V _{NC}	20	V
V_{CIN}	Input Voltage	Applied between: U _P -V _{UPC} , V _P -V _{VPC} , W _P -V _{WPC} , U _N , V _N , W _N , Br -V _{NC}	20	V
V_{FO}	Fault Output Supply Voltage	Applied between: U _{FO} -V _{UPC} , V _{FO} -V _{VPC} , W _{FO} -V _{WPC} , Fo-V _{NC}	20	V
I _{FO}	Fault Output Current	Sink current at U _{FO} , V _{FO} , W _{FO} , Fo terminals	20	mA

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HIGH POWER SWITCHING USE INSULATED TYPE

TOTAL SYSTEM

Symbol	Parameter	Conditions	Ratings	Unit
V _{CC(PROT)}	Supply Voltage Protected by SC	V _D =13.5 V~16.5 V, Inverter Part, Tvj=+125°C start	800	V
T_{stg}	Storage Temperature	-	-40 ~ +125	°C
Tc	Operating Case Temperature	-	-20 ~ +125	°C
V _{isol}	Isolation Voltage	60Hz, Sinusoidal, Charged part to Base plate, AC 1min, RMS	2500	V

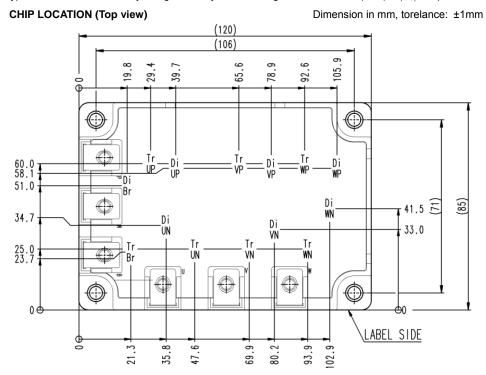
^{*:} Tc measurement point is just under the chip.

THERMAL RESISTANCE

Coursels al	Daramatas	Conditions		Limits		I Imit
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$R_{th(j-c)Q}$		Inverter, Junction to case, IGBT, per 1 element (Note1)	-	-	0.17	
$R_{th(j-c)D}$		Inverter, Junction to case, FWD, per 1 element (Note1)	-	-	0.25	K/W
$R_{th(j-c)Q}$	Thermal Resistance	Brake, Junction to case, IGBT, per 1 element (Note1)	-	-	0.26	I IVVV
$R_{th(j-c)D}$		Brake, Junction to case, FWD, per 1 element (Note1)	-	-	0.41	
R _{th(c-s)} Cor	Contact Thermal Resistance	Case to heat sink, per 1 module,	_	8.4	_	K/kW
	Contact Thermal Nesistance	Thermal grease applied (Note.1, 2)		0.1		TORVV

Note1. If you use this value, $R_{\text{th(s-a)}}$ should be measured just under the chips.

Note2. Typical value is measured by using thermally conductive grease of λ =0.9W/(m·K), $D_{\text{(C-S)}}$ =50 μ m.



Tr** : IGBT Di** : FWD

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PM100RG1C120

HIGH POWER SWITCHING USE

INSULATED TYPE

ELECTRICAL CHARACTERISTICS (Tvj= 25°C, unless otherwise noted)

INVERTER PART

Complete	Parameter Conditions				Limits			Unit
Symbol	Parameter	Condition	ıs		Min.	Тур.	Max.	Unit
		V -15 V L -100 A	Tui=25 °C	Terminal	-	-	1.85	
V	Collector-Emitter Saturation Voltage	V _D =15 V, I _C =100 A	Tvj=25 °C	Chip	-	1.3	-	V
V _{CEsat}	CEsat Concetor-Emitter Catalation voltage	\/ =0\/ Bulged (Fig.1)	Tvj=125 °C	Terminal	-	-	2.1	V
		V _{CIN} =0 V, Pulsed, (Fig.1) Tvj=125 °C	Chip	-	1.5	1		
		V _D =15 V, I _E =100 A,	Tvj=25 °C	Terminal	-	-	2.4	V
V	/ _{EC} Emitter-Collector Voltage	V _D =13 V, I _E =100 A,	1 Vj-25 C	Chip	-	1.75	-	
V EC		V _{CIN} = 15 V, pulsed, (Fig.2) Tvj=125 °C	Tvi=125 °C	Terminal	-	-	2.65	
			Chip	-	1.95	ı		
t _{on}		$V_D=15 \text{ V}, V_{CIN}=0 \text{ V} \longleftrightarrow 15 \text{ V},$			0.3	0.8	1.2	
t _{rr}		V _{CC} =600 V, I _C =100A,			-	0.2	0.4	
t _{c(on)}	Switching Time	Tvj=125 °C,			-	0.2	0.4	μs
t _{off}		Inductive Load			-	1.2	2.8	
t _{c(off)}		(Fig.3, 4)			-	0.4	1.2	
	Collector Emitter Cut off Current	V _{CE} =V _{CES} , V _D =15 V,		Tvj=25 °C	-	-	1	m 1
I _{CES} Collector-Emitter	Collector-Emitter Cut-off Current	V _{CIN} =15 V (Fig.5)		Tvj=125 °C	-	-	10	mA

BRAKE PART

Cumbal	Doromotor	Condition	Conditions			Limits		Unit
Symbol	Parameter	Condition	15		Min.	Тур.	Max.	Offic
		V _D =15 V, I _C =50A	Tvj=25 °C	Terminal	-	-	1.75	
			Chip	-	1.3	1		
V _{CEsat}	Collector-Emitter Saturation Voltage	V _{CIN} =0 V, Pulsed, (Fig.1)	Tvi=125 °C	Terminal	-	-	2.0	V
			1 0 123 0	Chip	-	1.5	-	
		Total	Tv:-25 °C	Terminal	-	-	2.35	
\ /	Diode Forward Voltage	I _F =50A	Tvj=25 °C	Chip	-	1.75	-	V
$V_{\sf FM}$	Diode Forward Voltage	I _F =50A	Tvi=105 °C	Terminal	-	-	2.6	V
		Tvj=125 °C		Chip	-	1.95	-	
	0-11	V V 45VV 45V (5:-	· .	Tvj=25 °C	-	-	1	4
Ces Collector-Emitter Cut-off	Collector-Emitter Cut-off Current	ctor-Emitter Cut-off Current V _{CE} =V _{CES} , V _D =15 V, V _{CIN} =15 V (Fig.5)	J.5)	Tvj=125 °C	-	-	10	mA

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PM100RG1C120

HIGH POWER SWITCHING USE

INSULATED TYPE

ELECTRICAL CHARACTERISTICS (Tvj = 25°C, unless otherwise noted)

CONTROL PART

Cumbal	Parameter	Conditions			Limits		Unit
Symbol	Parameter	Conditions		Min.	Тур.	Max.	Unit
		V -45 V V -45 V	V _{P1} -V _{PC}	-	4	6	
	Circuit Current	V _D =15 V, V _{CIN} =15 V	V _{N1} -V _{NC}	-	16	24	
I _D	Circuit Current	V _D =15 V, V _{CIN} =0 V←15 V, V _{CC} =800 V	V _{P1} -V _{PC}	-	29	35	mA
		I _C =0A, Tvj=125 °C, f _C ≤20kHz	V _{N1} -V _{NC}	-	103	120	
$V_{th(ON)}$	Input ON Threshold Voltage	Applied between:		1.2	1.5	1.8	V
$V_{th(OFF)}$	Input OFF Threshold Voltage	$ U_{P}\text{-}V_{UPC},V_{P}\text{-}V_{VPC},W_{P}\text{-}V_{WPC},U_{N},V_{N},W_{N},$	Br-V _{NC}	1.7	2.0	2.3] V
SC :	Short Circuit Trip Loyal		Inverter	200	-	-	^
	Short Circuit Trip Level	-20≤Tvj≤125 °C, V _D =15 V (Fig.3, 6)	Brake	100	-	-	A
t _{d(SC)}	Short Circuit Current Delay Time	V _D =15 V, Tvj=125 °C (Fig.3, 6)	V _D =15 V, Tvj=125 °C (Fig.3, 6)		2.0	-	μs
ОТ	Out Town and the Due to stick	Detect to many exercises of ICDT object our	Trip level	150	-	-	- °C
OT _(hys)	Over Temperature Protection	Detect temperature of IGBT chip surface	Hysteresis	-	20	-	
UV _t	Supply Circuit		Trip level	11.0	12.0	12.7	V
UV _r	Under-Voltage Protection	-	Reset level	-	12.5	-] V
I _{FO(H)}	Facility Contract Comment	V 45 V V 45 V (N-4-0)		-	-	0.01	^
I _{FO(L)}	Fault Output Current	V _D =15 V, V _{FO} =15 V (Note3)		-	10	15	mA
			ОТ	-	8.0	-	
t _{FO}	Fault Output Pulse Width	V _D =15 V (Note3)	UV	-	4.0	-	ms
			sc	-	2.0	-	

Note3. Fault output is given only when the internal SC, OT & UV protections schemes of either upper or lower arm device operate to protect it.

MECHANICAL RATINGS AND CHARACTERISTICS

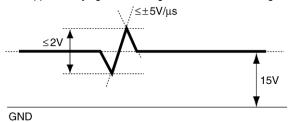
Symbol	Parameter	Conditions		Limits		Unit
Syllibol	Falametei	Conditions	Min.	Тур.	Max.	Offic
Ms	Mounting Torque	Mounting part screw : M5	2.5	3.0	3.5	N•m
M_t	Mounting Torque	Main terminal part screw : M5	2.5	3.0	3.5	INTIII
m	mass	-	-	425	-	g

RECOMMENDED CONDITIONS FOR USE

Symbol	Parameter	Conditions	Recommended value	Unit
V _{CC}	Supply Voltage	Applied across P-N terminals	≤ 800	V
V_D	Control Supply Voltage	Applied between: VUP1-VUPC, VVP1-VVPC, VWP1-VWPC, VN1-VNC (Note4)	15.0±1.5	V
V _{CIN(ON)}	Input ON Voltage	Applied between :	≤ 0.8	V
$V_{CIN(OFF)}$	Input OFF Voltage	U_{P} - V_{UPC} , V_{P} - V_{VPC} , W_{P} - V_{WPC} , U_{N} , V_{N} , W_{N} , Br - V_{NC}	≥ 9.0	V
f _{PWM}	PWM Input Frequency	Using Application Circuit of Fig. 8	≤ 20	kHz
t _{dead}	Arm Shoot-through Blocking Time	For IPM's each input signals (Fig.7)	≥ 2.5	μs

This product is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU.

Note4. With ripple satisfying the following conditions: dv/dt swing ≤ ±5 V/µs, Variation ≤ 2 V peak to peak



INSULATED TYPE

PRECAUTIONS FOR TESTING

- 1. Before applying any control supply voltage (V_D), the input terminals should be pulled up by resistors, etc. to their corresponding supply voltage and each input signal should be kept off state.
 - After this, the specified ON and OFF level setting for each input signal should be done.
- 2. When performing "SC" tests, the turn-off surge voltage spike at the corresponding protection operation should not be allowed to rise above V_{CES} rating of the device.

(These test should not be done by using a curve tracer or its equivalent.)

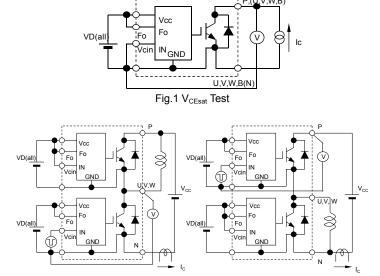
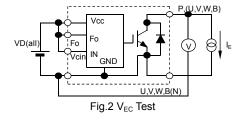


Fig.3 Switching time and SC test circuit



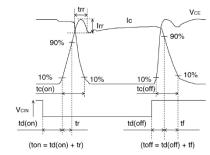


Fig.4 Switching time test waveform

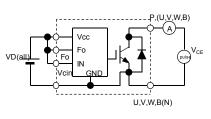


Fig.5 I_{CES} Test

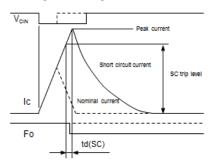
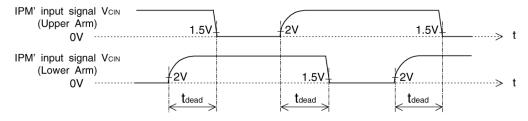


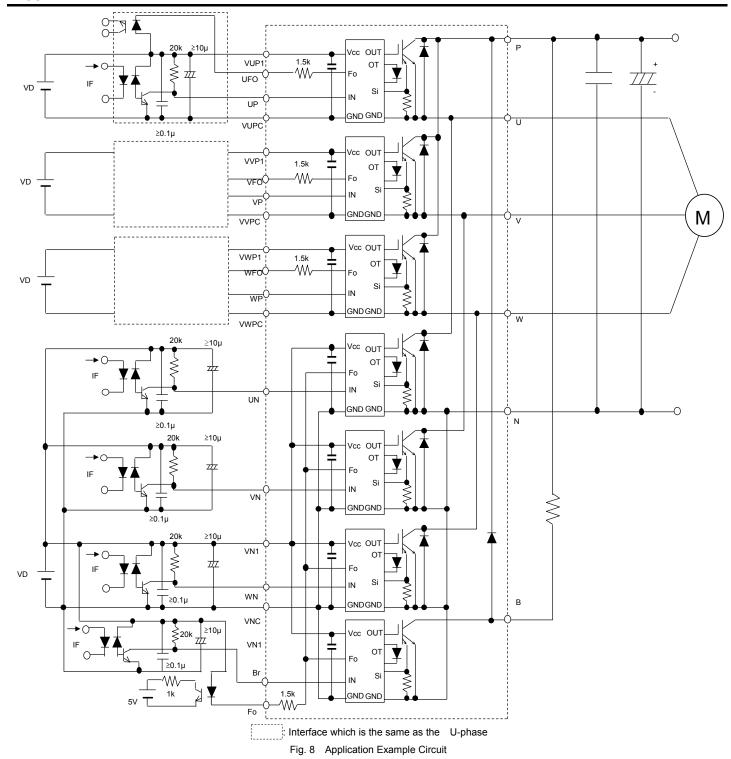
Fig.6 SC test waveform



1.5V: Input on threshold voltage Vth(on) typical value, 2V: Input off threshold voltage Vth(off) typical value

Fig. 7 Dead time measurement point example

INSULATED TYPE

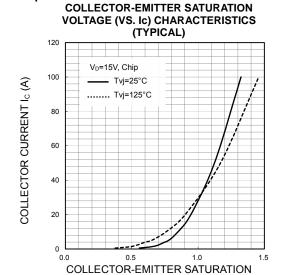


NOTES FOR STABLE AND SAFE OPERATION;

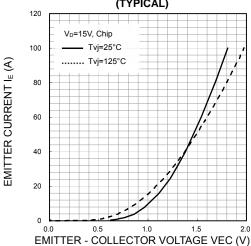
- Design the PCB pattern to minimize wiring length between opto-coupler and IPM's input terminal, and also to minimize the stray capacity between the input and output wirings of opto-coupler.
- · Connect low impedance capacitor between the Vcc and GND terminal of each fast switching opto-coupler.
- Fast switching opto-couplers: t_{PLH} , $t_{PHL} \le 0.8 \mu s$, Use High CMR type.
- Slow switching opto-coupler: CTR > 100% (*can be applied to Brake part input signal, in this case, resistor should be selected properly).
- Use 4 isolated control power supplies (V_D). Also, care should be taken to minimize the instantaneous voltage charge of the power supply.
- Make inductance of DC bus line as small as possible, and minimize surge voltage using snubber capacitor between P and N terminal.

INSULATED TYPE

PERFORMANCE CURVES Inverter part

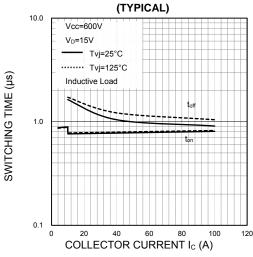


FREE WHEELING DIODE FORWARD CHARACTERISTICS (TYPICAL)

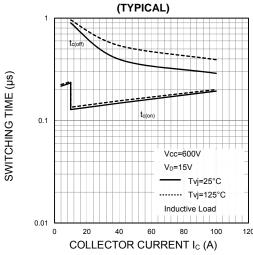


SWITCHING TIME (ton, toff) CHARACTERISTICS (TYPICAL)

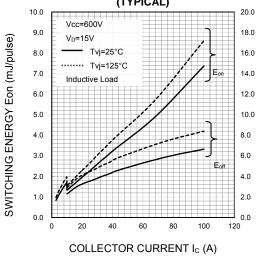
VOLTAGE VCEsat (V)



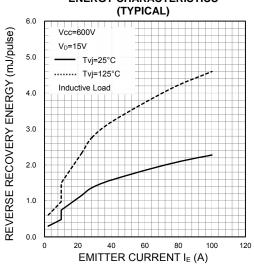
SWITCHING TIME (t_{c(on)}, t_{c(off)})
CHARACTERISTICS



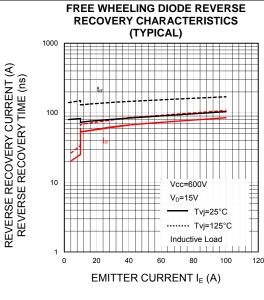
SWITCHING ENERGY CHARACTERISTICS (TYPICAL)

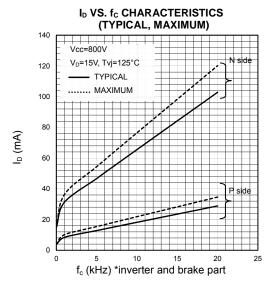


FREE WHEELING DIODE REVERSE RECOVERY ENERGY CHARACTERISTICS

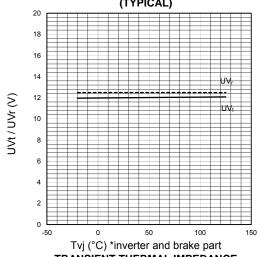


SWITCHING ENERGY Eoff (mJ)

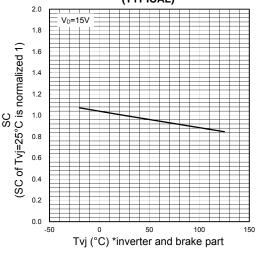




UV TRIP LEVEL VS. Tvj CHARACTERISTICS (TYPICAL)





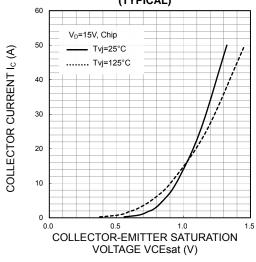


TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (TYPICAL)

ш			_	_	
2	Ri	0.0124	0.0739	0.3505	0.5632
Ž	ті (sec)	1.961E-05	0.0014	0.0179	0.0944
닖	10				
₹					
=					
₹					
전	1				
뿌					
Fφ					
日空					
洪	0.1				
ž					
№					
_					
Щ	0.01	Singl	e Pulse		1111
2	0.01		T Part;		
₹			unit base: R D Part;	tn(j-c)Q=0.1	/K/W
₹			unit base: R	th(j-c)D=0.2	5K /W
NORMARIZED TRANSIENT THERMAL IMPEDANCE Zth(j-c)	0.001				
_	0.0001	0.0001 0.0	01 0.01	0.1	1 10
			TIME (s)		

PERFORMANCE CURVES Brake part

COLLECTOR-EMITTER SATURATION VOLTAGE (VS. Ic) CHARACTERISTICS (TYPICAL)



WILL TVj=125°C

EMITTER - COLLECTOR VOLTAGE VEC (V)

V_D=15V, Chip

Tvj=25°C

FREE WHEELING DIODE FORWARD

CHARACTERISTICS

(TYPICAL)

60

TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (TYPICAL)

111	i	1	2	3	4	
Ş	Ri	0.0124	0.0739	0.3505	0.563	2
₹	ті (sec)	1.961E-05	0.0014	0.0179	0.094	4
NORMARIZED TRANSIENT THERMAL IMPEDANCE Zth(j-c)	10					_
Ĕ						Ħ
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Ž						ı
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Š	V.1					Ħ
₽						
						H
ZE	0.01		le Pulse BT Part;			
쪼		Per	unit base: R	th(j-c)Q=0.2	.6K /W	#
Ž			'D Part; · unit base: R	9th/i_c\D=0_4	1K AN	Ħ
R			UIIII Dase. N	.uig-c)D-0.4		t
Z	0.001	0.0001 0.0	001 0.01	0.1	1	Ш 10
	0.00001	0.0001 0.0	TIME (s)	0.1		.0
			· · · · · · · (3)			

PM100RG1C120

HIGH POWER SWITCHING USE INSULATED TYPE

Keep safety first in your circuit designs!

This product is designed for industrial application purpose. The performance, the quality and support level of the product is guaranteed by "Customer's Std. Spec.".

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